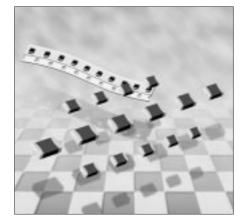


CHIP THERMISTOR

Chip thermistors are specially processed, highly reliable thermistors with electrodes of silver and palladium alloy. They can be face bonded to act as thermal compensators for ICs and they are manufactured in sizes down to 1 square mm, they can also be used to detect temperature with relatively small time constants.

EIAJ type

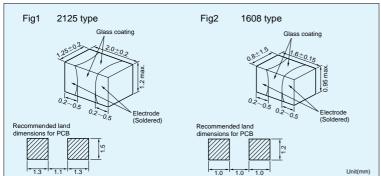
Part nui	nber					
10K (C 15-2125 - 1P					
	R25=±1%					
	Dimension 2125: Fig1					
	1608: Fig2					
	Chip thermistor					
	Rated zero-power resistance at 25°C 10Κ:10kΩ					

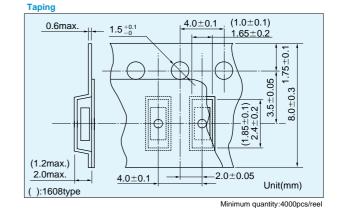




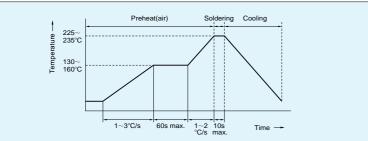
• Do not expose the thermistors to high soldering heat for too long. (260°C for not longer than 10s is recommened)

Dimensions





Reflow soldering profile



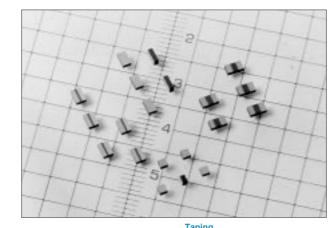
Specifications

Part No.	R25 ^{*1}	B value*2	Dissipation factor (mW/ °C)	Thermal time constant(s)*3	Rated power at 25 °C(mW)	Operating temp. range(°C)
10KC15-2125-1P	10k $\Omega\pm$ 1%	3435K±1%	1.0	7.5	5.0	-40~125
10KC15-2125-2P	10kΩ±2%	3435K±1%	1.0	7.5	5.0	-40~125
10KC15-2125-3P	10kΩ±3%	3435K±1%	1.0	7.5	5.0	-40~125
10KC15-1608-1P	10kΩ±1%	3435K±1%	0.9	5.0	4.5	-40~125
10KC15-1608-2P	10kΩ±2%	3435K±1%	0.9	5.0	4.5	-40~125
10KC15-1608-3P	10kΩ±3%	3435K±1%	0.9	5.0	4.5	-40~125

*1 R25 : Rated zero-power resistance value at 25°C.
*2 B value : determined by rated zero-power resistance at 25°C and 85°C.
*3 Time when thermistor temperature reaches 63.2% of the temperature difference. The value is measured in the air.

CHIP THERMISTOR

Chip thermistors are specially processed, highly reliable thermistors with electrodes of silver and palladium alloy. They can be face bonded to act as thermal compensators for ICs and they are manufactured in sizes down to 1 square mm, they can also be used to detect temperature with relatively small time constants.



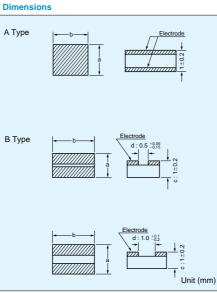
Part number

1K C 5-2040

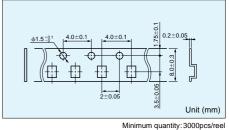
- Dimension a×b (2.0mm×4.0mm) Dimension d (0.5mm)
- Chip thermistor
 - -Rated zero-power resistance at 25°C 10K:10k Ω

Precautions

- •The thermistors are not moisture proof, so store them in a dry place.
- Do not expose the thermistors to high soldering heat for too long.(220°C for not longer than 5 sec. is recommended)



Taping Some types can be taped in the following shape :



Specifications

А Туре			B Type(d=0.5)			B Type(d=1.0)		
Part No	R25 ^{*1}	B value*2	Part No	R25*1	B value*2	Part No	R25*1	B value*2
500C0-1717	$0.5 \mathrm{k}\Omega \pm 10\%$	3250K±5%	500C5-2039	0.5kΩ±10%	3250K±5%	-	-	_
1KC0-1717	1.0k $\Omega\pm$ 10%	3400K±5%	1KC5-2040	1.0kΩ±10%	3400K±5%	1KC10-3239	1.0kΩ±10%	3250K±5%
2KC0-1212	2.0kΩ±10%	3400K±5%	2KC5-2020	2.0kΩ±10%	3400K±3%	2KC10-3220	2.0kΩ±10%	3230IX-1370
5KC0-1111	5.0kΩ±10%	3500K±5%	5KC5-2012	5.0kΩ±10%	3500K±5%	5KC10-3224	5.0kΩ±10%	3500K±5%
10KC0-1717	10.0k $\Omega\pm$ 10%	3850K±5%	10KC5-2038	10.0kΩ±10%	3850K±5%	10KC10-3212	10.0kΩ±10%	3300K±5%
20KC0-1212	20.0kΩ±10%	303011-376	20KC5-2019	20.0kΩ±10%	3030K±5%	20KC10-3238	20.0kΩ±10%	3850K±5%

*1 R2s : Rated zero-power resistance value at 25°C. *1 B value : determined by rated zero-power resistance at 25°C and 85°C. Operating temp. range: -30~110°C